

Future computing (for NWP and EO)

Martin Palkovic

My background and experience

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Imec Belgium

Data Transfer and Storage Exploration Methodology

ADRES processor (VLIW+CGA architecture)

IT4Innovations Czech National Supercomputing Center

Establishing national supercomputing centre (DC+HPC)

One of the largest Xeon Phi clusters in EU

Codasip

RISC-V with customised ISA extensions + LLVM

ECMWF

ECMWF new DC project in Italy + new HPCF

European Centre for Medium-Range Weather Forecasts (ECMWF)



Inter-governmental Organisation, Established in 1975

- 35 States (23 Member & 12 Co-operating States)
- Headquarter in Reading, UK + DC in Bologna, Italy + Bonn, Germany (EU funded activities)

Operational Numerical Weather Prediction (NWP) centre

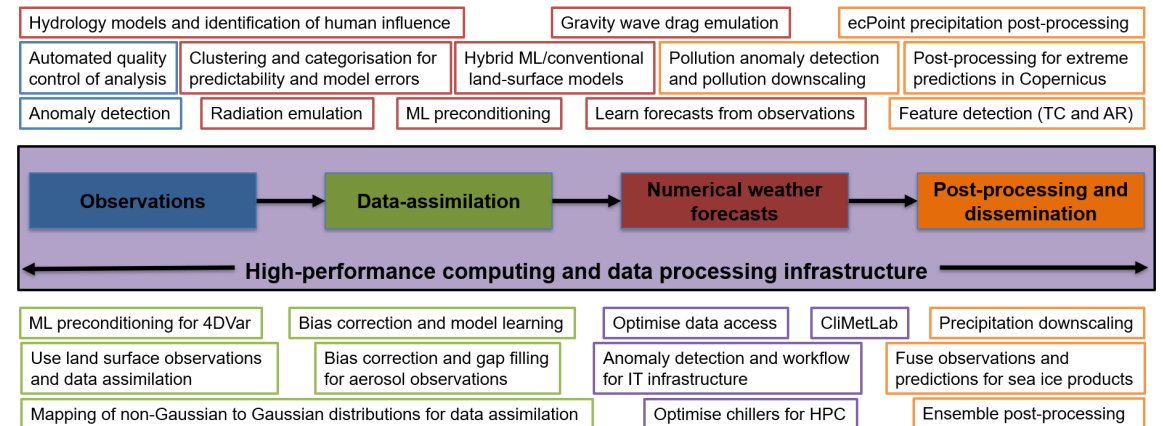
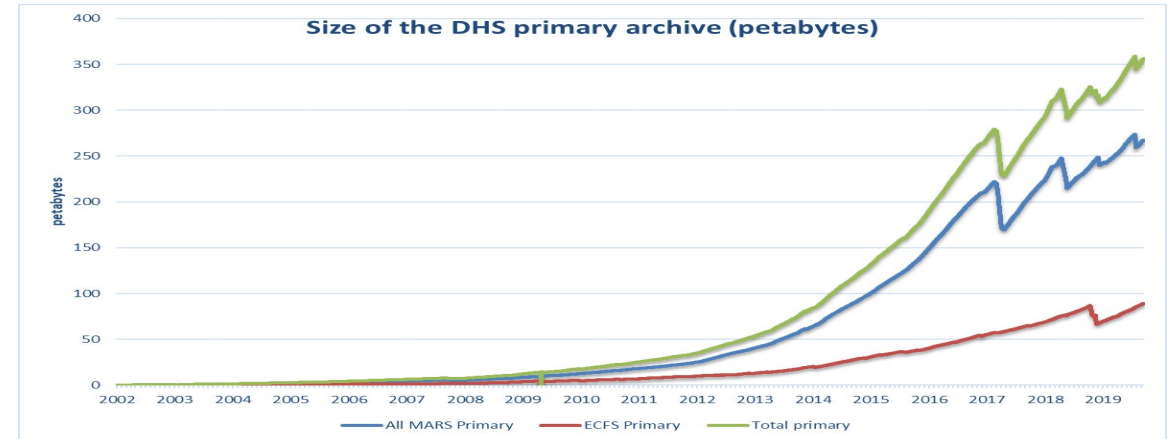
- Research institute and a 24/7 operational service
- Twice daily generation of operational weather forecasts
- Assimilation of 60-80 million observations/day
- Archive of Petabytes of observations and forecast data

Computing services

- HPC facility globally one of the largest for NWP
- Cloud infrastructure for C3S, CAMS and WEkEO (DIAS) and the **European Weather Cloud**
- Climatological data : ~350 PB (daily growth of 250TB)
- Computational science and ML/AI

Challenges for computing in NWP and EO

- Heterogenous architectures and novel technologies
- Exponential increase of data
- Use of the cloud
- Use of AI/ML
- Remote working
- Federation of the resources



Challenges for computing in NWP and EO

- Backwards compatibility/familiarity with ISA



The screenshot shows a Business Wire news article. At the top left is the Business Wire logo with the tagline 'A BERKSHIRE HATHAWAY COMPANY'. To the right are navigation links: HOME, SERVICES, NEWS, EDUCATION, ABOUT US. A search bar is located on the far right. The main headline is 'CAES Gaisler Signs Contract with the European Space Agency for New Advanced Space Processor'. Below the headline is a sub-headline: '- New GR765 Microprocessor features octa-core system-on-chip; offers best-in-class integration and performance for reduced weight and power consumption.' The date and time are 'April 20, 2021 10:00 AM Eastern Daylight Time'. The main text starts with 'GOTHENBURG, Sweden--(BUSINESS WIRE)--CAES Gaisler announced today that it has received a contract from the European Space Agency (ESA) to fund the first phase to develop a new advanced processor for space applications. Developed in Sweden and based on the popular LEON5FT Fault Tolerant Processor Core, the GR765 Microprocessor meets market demand for high-performing processors, offering a higher level of integration with more functionality on the chip to reduce weight and keep power consumption low.' There are two quote boxes: one on the left in green text and one on the right in black text.

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CAES Gaisler Signs Contract with the European Space Agency for New Advanced Space Processor

- New GR765 Microprocessor features octa-core system-on-chip; offers best-in-class integration and performance for reduced weight and power consumption.

April 20, 2021 10:00 AM Eastern Daylight Time

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“The software compatibility and a common development environment makes it easy for a design team, already familiar with the LEON, to quickly come up to speed.”

CAES Gaisler’s products include world-leading embedded computer systems for harsh environments, with footprints throughout the solar system. The portfolio includes a suite of trusted fault-tolerant computing offerings for reliable system-on-a-chip solutions, based on the SPARC and RISC-V processor architectures. The product offering comprises IP core building blocks, radiation hardened components, flight software & development tools, development hardware, test equipment and services.